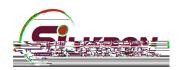


PDFN5x6-8

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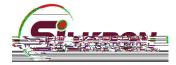
Symbol	Max.	Units	
I <sub>D</sub> @ T <sub>C</sub> = 25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V	100	
I <sub>D</sub> @ T <sub>C</sub> = 100°C	63	Α	
I <sub>DM</sub>	Pulsed Drain Current	400	
P <sub>D</sub> @T <sub>C</sub> = 25°C	Power Dissipation	78	W
V <sub>DS</sub>	Drain-Source Voltage	30	V
V <sub>GS</sub> Gate-to-Source Voltage		± 20	V
E <sub>AS</sub> Single Pulse Avalanche Energy @ L=0.5mH		196	mJ
T <sub>J</sub> T <sub>STG</sub>	Operating Junction and Storage Temperature Range	-55 to +150	°C

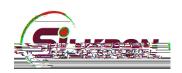


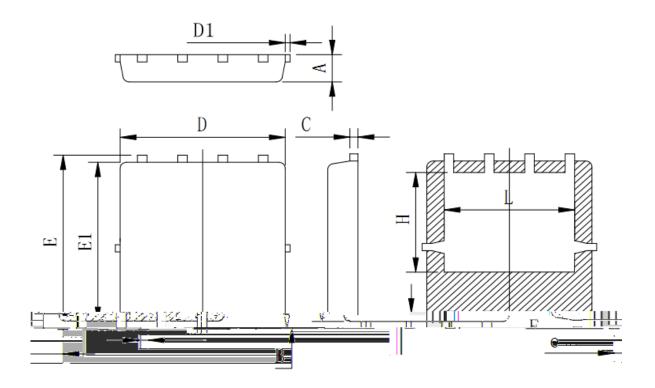
Symbol	Characterizes	Тур.	Max.	Units
	Junction-to-case			

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
V <sub>(BR)DSS</sub>	Drain-to-Source breakdown voltage	30			V	$V_{GS} = 0V, I_D$
R <sub>DS(on)</sub> Static Drain-to-Source	Static Prain to Source on registance		2.8	3.8	m	$V_{GS}=10V, I_{D}=30A$
	Static Drain-to-Source on-resistance	n-resistance	4	5.2		V <sub>GS</sub> =4.5V,I <sub>D</sub> = 20A
$V_{GS(th)}$	Gate threshold voltage	1	•	2.2	V	$V_{DS} = V$

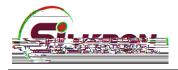
Gate threshold voltage







Symbol	Min	Тур	Max
<b>^</b>	A.^ ^^	V.50° 05	V.43 00
0.68	В	0.48	0.58
0.30	C	0.20	0.254
5.20	5.40	1) =====	5.00
	( <del>) _ 1</del> 5	Dall	
6.05	6.20	E	5.90
5.55	5.70	El	5.40
1.27	1.32	e	1.22
0.30	0.35	F.	0.25
3.47	3.67	H	3.27
1 Desc.	1200	17.0	782



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